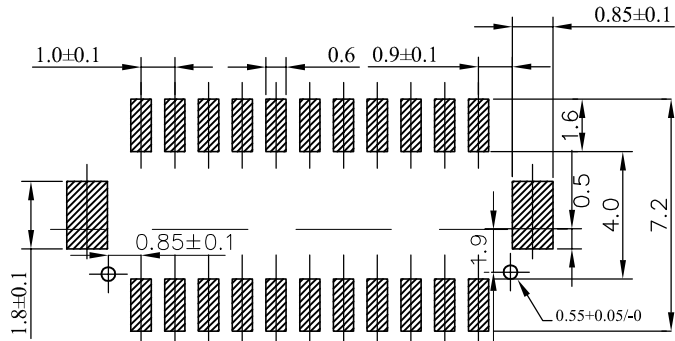
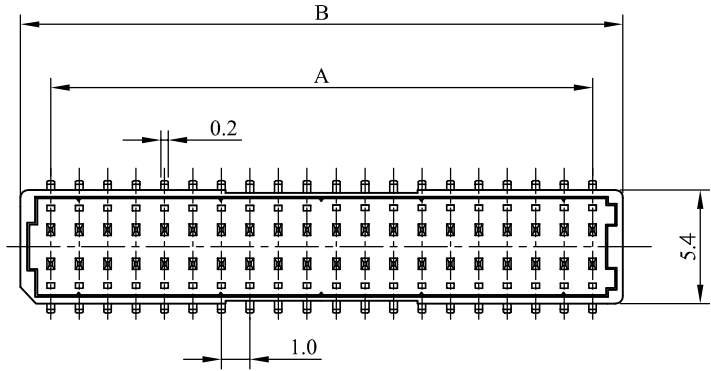
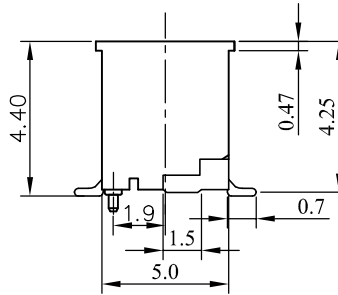
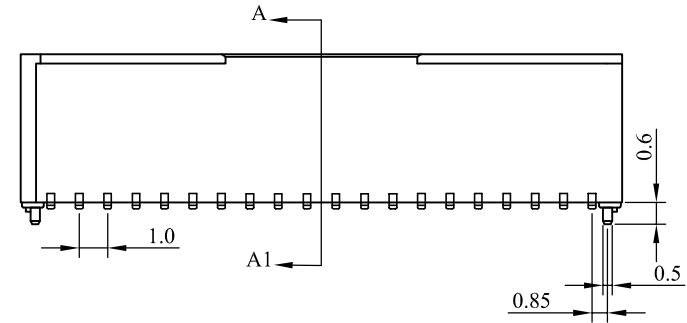


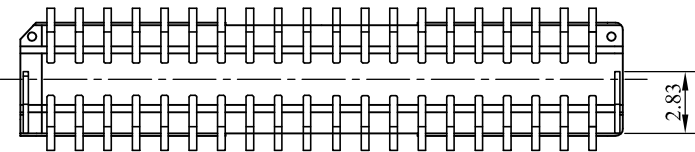
8 7 6 5 4 3 2 1



RECOMMENDED P.C. BOARD PATTERN DIM.



SEE:A-A1



Specifications

Electrical

Voltage Rating: 50VAC DC

Current Rating: 1.0A AC DC (AWG 28)

Contact Resistance: Initial value/20mΩmax

After environmental testing/40mΩ max

Insulation Resistance: 100MΩmin

Temperature Range: -25℃~+85℃

Withstanding voltage:500V AC/minute

Material and Finish

Header contact:Phosphor bronze,nickel-undercoated,
tin-plated or gold-plated

Water:Glass-filled polyamide,UL94V-0,natural(ivory)

Solder tad:Brass,copper-undercoated,tin/lead-plated

Circuits	Dimension mm (in.)	
	A	B
2*10	9.0(.354)	12.3(.484)
2*15	14.0(.551)	17.3(.681)
2*20	19.0(.748)	22.3(.878)
2*25	24.0(.945)	27.3(.1.075)

Revision Record					純通有限公司		
LTR	Description	DR	CHK	Date			
Name:					SHD1.0mm Wire to Board Wafer SMT 180W(雙排)		
Drawing No.					5500-2*_P(100SH)		
General Tolerances: X.XX ± 0.2 X X ± 0.3		Unit: mm	Scale: ROM	DR Cai zheng ji	CHK Jory	APPD Jefferson	

Customer Drawing